

Title (en)
METHOD FOR PRODUCING A COMPONENT

Title (de)
VERFAHREN ZUR HERSTELLUNG EINES BAUTEILS

Title (fr)
PROCÉDÉ DE FABRICATION D'UNE PIÈCE

Publication
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Application
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Abstract (en)
[origin: WO2012083922A1] In a method for producing a component with increased thermal conductivity by building it up layer by layer, at least one portion of the component is built up by steps which comprise at least the following: a) applying a layer portion with predetermined dimensions of a composite material of a metal and/or a metal alloy and particles of highly heat conductive material, which comprises diamond and/or cubic boron nitride, in a predetermined area on a base layer by melting the metal or the metal alloy by means of a heat source in such a way that the metal and/or the metal alloy form within the predetermined dimensions a contiguous matrix in which particles of the highly heat conductive material are embedded, and subsequently leaving it to cool down. A component that can be produced by the method, a method for producing the composite material and a composite material that can be produced by this method are likewise disclosed.

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